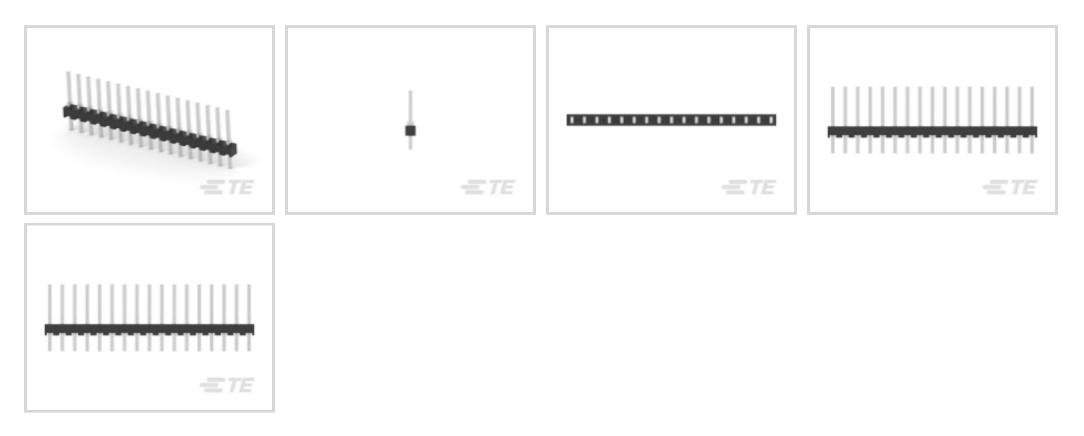
1-87348-7 - ACTIVE

TE Internal #: 1-87348-7 PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 17

Number of Rows: 1

Features

Product Type Features



| PCB Connector Assembly Type | PCB Mount Header | |
|---|-----------------------|--|
| Connector System | Board-to-Board | |
| Header Type | Unshrouded | |
| Sealable | No | |
| Connector & Contact Terminates To | Printed Circuit Board | |
| Configuration Features | | |
| Connector Contact Load Condition | Fully Loaded | |
| | | |
| PCB Mount Orientation | Vertical | |
| PCB Mount Orientation Number of Positions | Vertical 17 | |
| | | |
| Number of Positions | 17 | |
| Number of Positions Number of Rows | 17 | |
| Number of Positions Number of Rows Board-to-Board Configuration | 17 | |

PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



Body Features

| Primary Product Color | Black |
|--|-------------------------------|
| Contact Features | |
| Contact Shape & Form | Square |
| Contact Mating Area Plating Material Finish | Bright |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin-Lead |
| Contact Base Material | Phosphor Bronze |
| Contact Mating Area Plating Material | Tin-Lead |
| Contact Mating Area Plating Material Thickness | 2.54 – 5.08 μm[100 – 200 μin] |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Termination Post & Tail Length | 3.18 mm[.125 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment | Without |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Housing Material | Nylon-GF |
| Dimensions | |
| PCB Thickness (Recommended) | 1.57 mm[.062 in] |
| Usage Conditions | |
| Housing Temperature Rating | Standard |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Solder Process Feature | Board Standoff |
| Circuit Application | Signal |
| Industry Standards | |

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| UL Flammability Rating | UL 94V-0 |
|--|--|
| Packaging Features | |
| Packaging Type | Carton |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| EU RoHS Directive 2011/65/EU | Not Compliant |
| EU ELV Directive 2000/53/EC | Compliant with Exemptions |
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content | BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources. |
| Solder Process Capability | Not reviewed for solder process capability |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



TE Part # 1-5535677-7 17 MODII HORZ SR CE 100CL

Customers Also Bought



| CRGS2512 | 5% | 1M8 | |
|-----------|-----|-----|--|
| CINUSZUIZ | 570 | | |

PT570N20

Documents

Product Drawings

17 MODII HDR SRST UNSHRD .100

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_1-87348-7_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-87348-7_L.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-87348-7_L.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

S For support call+1 800 522 6752

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PCB Mount Header, Vertical, Board-to-Board, 17 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



Agency Approvals UL

English